May 2009

FDMS8672S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> 30V, 35A, 5mΩ

# Features

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- Max  $r_{DS(on)}$  = 5.0m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 17A
- Max  $r_{DS(on)}$  = 7.0m $\Omega$  at  $V_{GS}$  = 4.5V,  $I_D$  = 15A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- RoHS Compliant

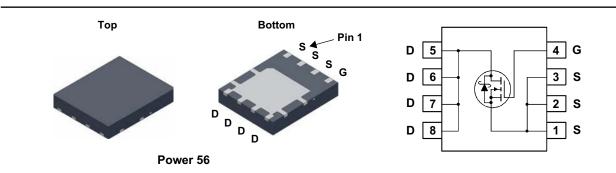


# **General Description**

The FDMS8672S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

# Application

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



# MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25°C		35		
I <sub>D</sub>	-Continuous (Silicon limited)	T <sub>C</sub> = 25°C		90		
	-Continuous	T <sub>A</sub> = 25°C		17	— A	
	-Pulsed			200		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	337	mJ	
P	Power Dissipation	T <sub>C</sub> = 25°C		50	14/	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

### **Thermal Characteristics**

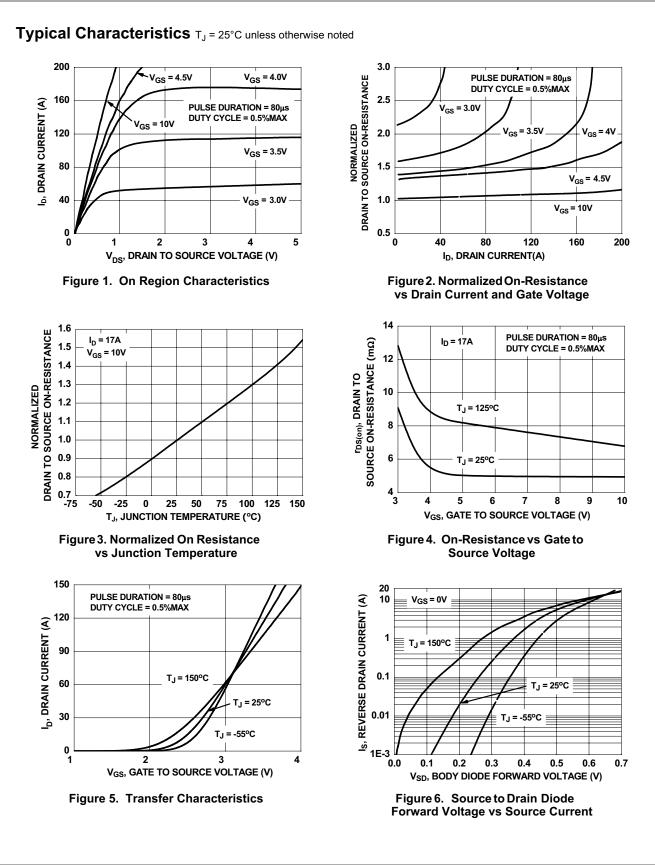
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (N	lote 1a)	50	0/11

### Package Marking and Ordering Information

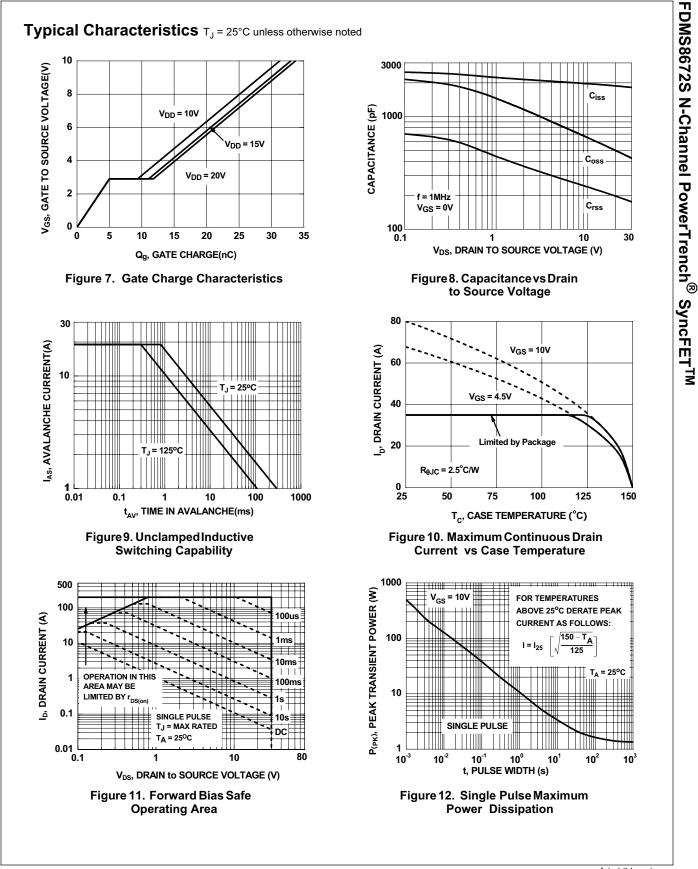
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8672S	FDMS8672S	Power 56	13"	12mm	3000 units

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V	30			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 50$ mA, referenced to 25°C		23		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24V, V_{GS} = 0V$			500	μA
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	atoristics			•		
			4	4.5	2	N
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1mA$	1	1.5	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 50mA, referenced to 25°C		-5.4		mV/°C
		$V_{GS} = 10V, I_D = 17A$		4.0	5.0	
DS(on)	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 15A$		5.2	7.0	mΩ
	Forward Transconductance	$V_{GS} = 10V, I_D = 17A, T_J = 125^{\circ}C$		6.1 72	7.8	
JFS	Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 17A		12		S
Oynamic (	Characteristics					
C <sub>iss</sub>	Input Capacitance			1890	2515	pF
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V f = 1MHz		555	740	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1101112		205	380	pF
₹ <sub>g</sub>	Gate Resistance	f = 1MHz		1.1		Ω
Switching	Characteristics					
d(on)	Turn-On Delay Time			11	20	ns
·a(on) · ·	Rise Time	V <sub>DD</sub> = 15V, I <sub>D</sub> = 17A		17	31	ns
d(off)	Turn-Off Delay Time	$-V_{GS}$ = 10V, $R_{GEN}$ = 7 $\Omega$		27	44	ns
d(011)	Fall Time	-		7	14	ns
່ ຊ <sub>g(TOT)</sub>	Total Gate Charge at 10V	V <sub>GS</sub> = 0V to 10V		33	47	nC
$Q_{g(4.5V)}$	Total Gate Charge at 4.5V	$V_{GS} = 0V \text{ to } 4.5V V_{DD} = 15V,$		16	23	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 17A		5		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			6		nC
)rain-Sou	rce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.7A		0.4	0.7	V
	Reverse Recovery Time			20	32	ns
n Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 17A, di/dt = 300A/μs		16	28	nC
otes:	ined with the device mounted on a 1in <sup>2</sup> pad 2 oz copper pa	ld on a 1.5 x 1.5 in. board of FR-4 material. R <sub>θJC</sub> is	guaranteed			
	a. 50°C/W when mount a 1 in <sup>2</sup> pad of 2 oz copp	led on mir		en mounted of 2 oz coppe		

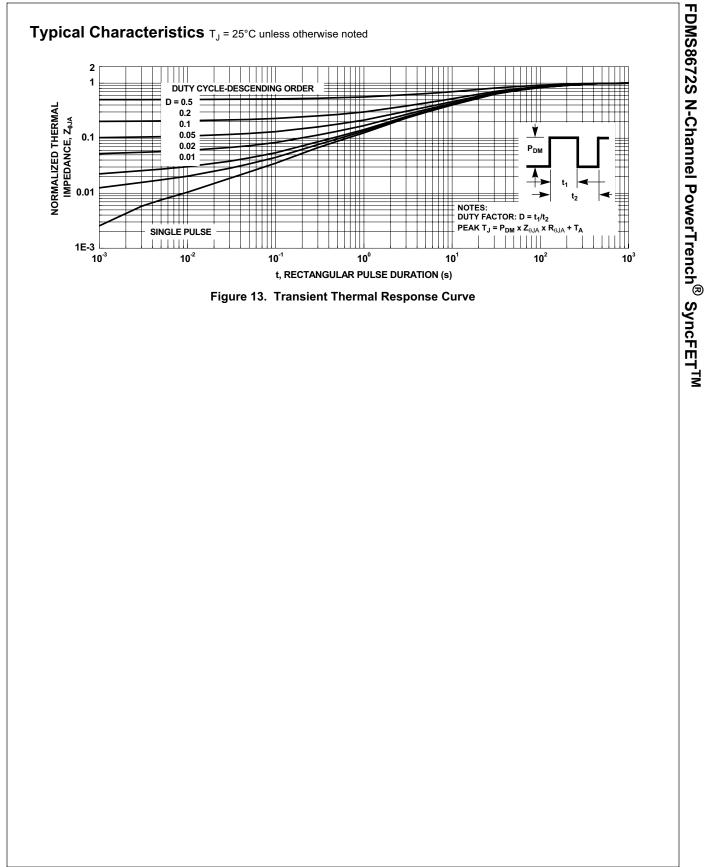
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# FDMS8672S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

# Typical Characteristics (continued)

## SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MoSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS8672S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

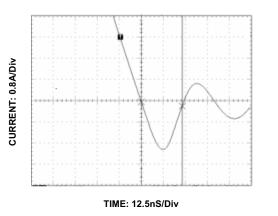


Figure 14. FDMS8672S SyncFET Body Diode Reverse Recovery Characteristics

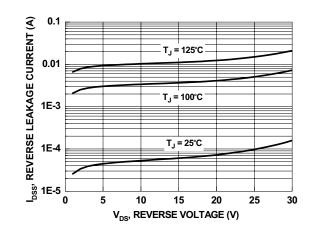
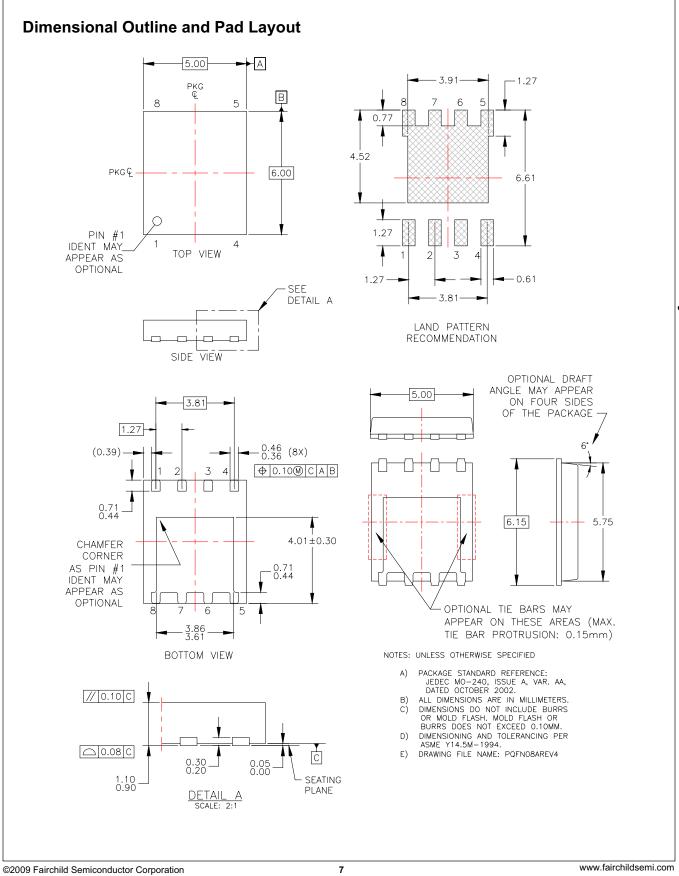


Figure 15. SyncFET Body Diode Reverse Leakage vs Drain to Source Voltage



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FDMS8672S Rev.C3



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